

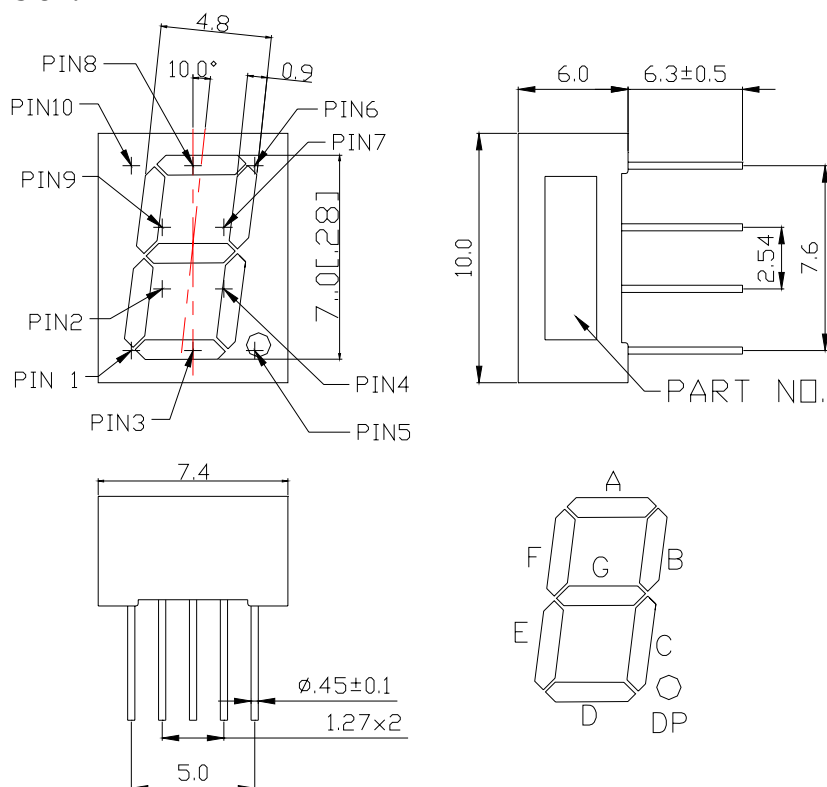
WCN1-0028CB-A11**SPECIFICATION**

WCN			CUSTOMER Confirmed
Prepared by	Checked by	Approved by	
Liu 2016-1-12	Athena		
REVISION RECORD			



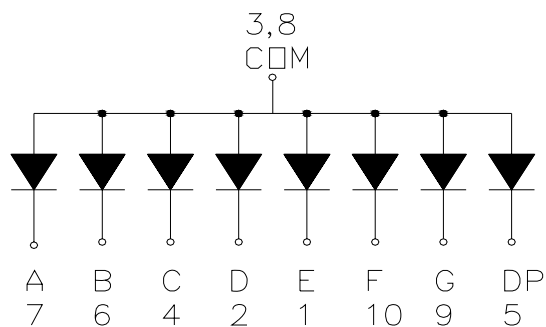
REVISION: A0

Outer Dimension:



Notes: Unless otherwise stated, the tolerance is $\pm 0.25\text{mm}$.

Circuit Diagram



Pin Connection:

PIN NO.	CONNECTION	PIN NO.	CONNECTION
1	Cathode E	6	Cathode B
2	Cathode D	7	Cathode A
3	Common Anode	8	Common Anode
4	Cathode C	9	Cathode G
5	Cathode DP	10	Cathode F

WCN Opto Group Co., Limited

■ Features:

- High Reliability
- Color: Blue
- Low Power Requirement
- Easy Assembly

■ Description:

- Single Digit LED Display
- Digit Height: 7.0mm(0.28")
- Black Face and Milky Segment

■ Absolute Maximum Rating (Ta=25℃):

Parameter	Symbol	Condition	Color	Rating	Units
Power Dissipation Per Segment	P _d	—	Blue	100	mW
Forward Current Per Segment	I _F	—	Blue	25	mA
Peak Forward Current Per Segment	I _{FP}	1/10 Duty 10KHz	Blue	100	mA
Reverse Voltage Per Segment	V _R	—	Blue	5	V
Operating Temperature Range	T _{opr}	—	—	-35~+85	℃
Storage Temperature Range	T _{stg}	—	—	-35~+85	℃

■ Electrical/Optical Characteristics Rating(Ta=25℃)

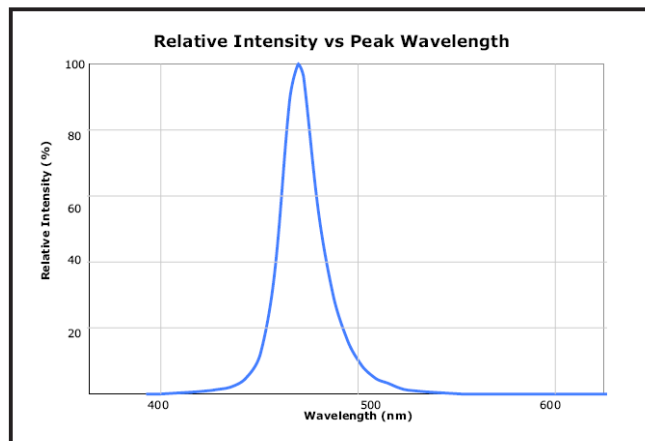
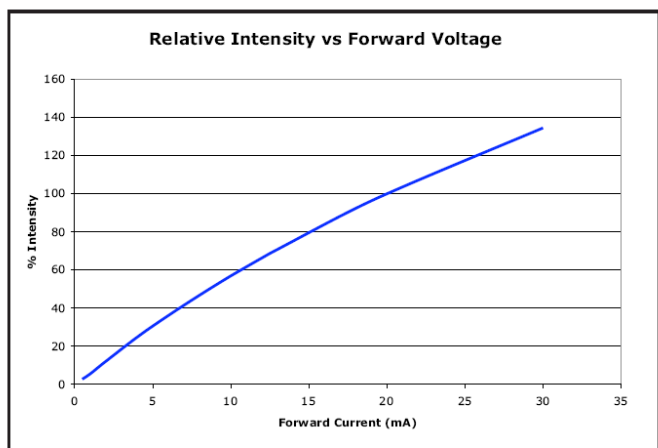
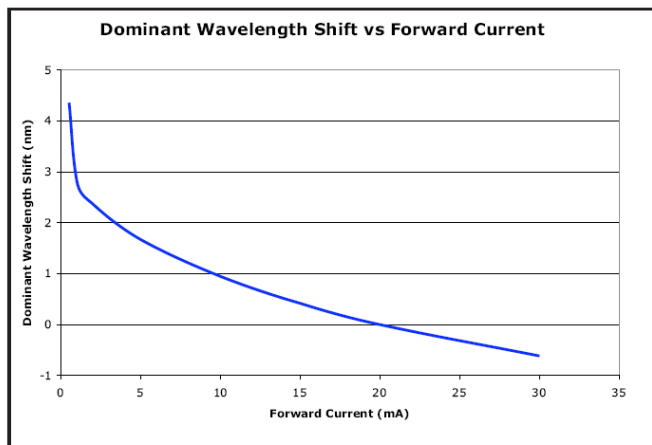
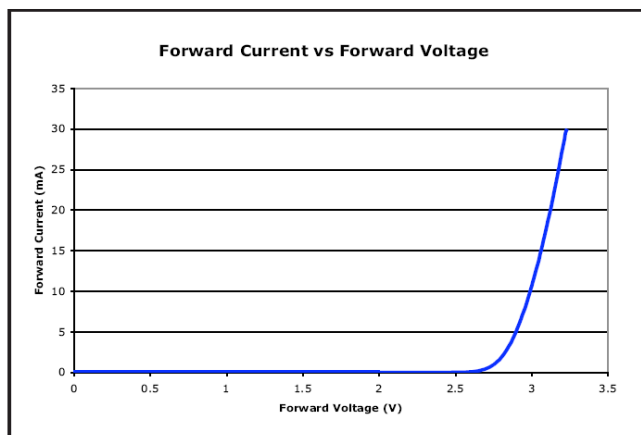
Item	Symbol	Test conditions	Location	Rating			Units
				Min.	Typ.	Max.	
Forward Voltage	V _F	I _F =20mA	Per Segment	—	3.40	4.00	V
Reverse Current	I _R	V _R =5V	Per Segment	—	—	100	μA
Luminous Intensity	I _V	I _F =10mA	Per Segment	1751	3500	—	μcd
Peak Emission Wave Length	λ _P	I _F =20mA	Per Segment	—	460	—	nm
	λ _D			460	467.5	475	
Spectral Line Half Width	△λ	I _F =20mA	Per Segment	—	20	—	nm
Luminous Intensity Matching Ratio (Segment to Segment)	I _{V-m}	I _F =10mA	—	—	—	1.2:1	

■ Luminous Intensity Sorting: (Luminous Intensity Tolerance is +/-10%)

Rank	Symbol	Condition	Min	Max	Unit
I	I	I _F =10mA	1751	2350	μcd
J	J	I _F =10mA	2351	3050	μcd
K	K	I _F =10mA	3051	4000	μcd
L	L	I _F =10mA	4001	5000	μcd
M	M	I _F =10mA	5001	6100	μcd

■ Soldering Conditions: Soldering Temp. ≤ +260℃, Soldering Time. ≤ 3sec.
(at 2mm Distance from The Case of Reflector Edge)

■ Typical Electro-Optical Characteristics Curve:



LED Displays Reliability Test:

CLASSIFICATION	TEST ITEM	DESCRIPTION AND TEST CONDITION
ENDURANCE TEST	OPERATION LIFE	EVALUATES RESISTANCE OF THE DEVICE WHEN OPERATED AT ELECTRICAL STRESS T_a = UNDER ROOM TEMPERATURE $I_F = I_{F \max}$
	HIGH TEMPERATURE HIGH HUMIDITY STORAGE	EVALUATES MOISTURE RESISTANCE OF THE DEVICE WHEN STORED FOR A LONG TERM AT HIGH TEMPERATURE AND HUMIDITY $T_a = 65 \pm 5^\circ\text{C}$ RH=90~95%RH TEST TIME=240 $\pm$ 2Hrs
	HIGH TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN HIGH TEMPERATURE $T_a = 85 \pm 5^\circ\text{C}$ (COB: $T_a = 65 \pm 5^\circ\text{C}$) TEST TIME=1000Hrs(-24Hrs, +72Hrs)
	LOW TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN LOW TEMPERATURE $T_a = -35 \pm 5^\circ\text{C}$ TEST TIME=1000Hrs(-24Hrs, +72Hrs)
ENVIRONMENTAL TEST	TEMPERATURE CYCLING	EVALUATES RESISTANCE OF DEVICE AT THERMAL STRESSES OR EXPANSION AND CONTRACTION $85^\circ\text{C} \sim 25^\circ\text{C} \sim -35^\circ\text{C} \sim 25^\circ\text{C}$ 30min 5min 30min 5min 10 CYCLES(COB: $T_{\text{hot}}=65^\circ\text{C}$, $T_{\text{cold}}=-25^\circ\text{C}$)
	THERMAL SHOCK	EVALUATES DEVICE STRUCTURE AND STRUCTURE AND MECHANICAL RESISTANCE WHEN SUDDENLY EXPOSED AT SERVE CHANGES $85 \pm 5^\circ\text{C} \sim -35 \pm 5^\circ\text{C}$ 10min 10min 10 CYCLES(COB: $T_{\text{hot}}=65^\circ\text{C}$, $T_{\text{cold}}=-25^\circ\text{C}$)
	SOLDERABILITY	EVALUATES SOLDERABILITY ON LEADS OF DEVICE $T_{\text{SOL}}=230 \pm 5^\circ\text{C}$ DWELL TIME=5 $\pm$ 1sec.
	SOLDER RESISTANCE	EVALUATES RESISTANCE TO THERMAL STRESS CAUSED BY SOLDERING $T_{\text{SOL}}=260 \pm 5^\circ\text{C}$ DWELL TIME=10 $\pm$ 1sec.

Package Pattern:

640 pcs / Red Expandable Polyethylene.

3840 pcs / Box(360*175*130mm).

23040 pcs / Carton(550*380*280mm).